

承 認 書
APPROVAL SHEET

CUSTOMER: 大眾電腦股份有限公司

APPLICABLE MODEL:

PART NO. 20-25373-00

DESCRIPTION FH23-39S-0.3SHW(05)

MANUFACTURER HIROSE

REMARK



育達電子股份有限公司

IIDA ELECTRONICS CO., LTD.

TEL:2509-7866 FAX:2509-7808

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					△				
△					△				

APPLICABLE STANDARD

RATING	OPERATING TEMPERATURE RANGE	-55°C TO 85°C	STORAGE TEMPERATURE RANGE	-10°C TO 50°C (PACKED CONDITION)
	VOLTAGE	30V AC	OPERATING OR STORAGE HUMIDITY RANGE	RELATIVE HUMIDITY 90 % MAX. (NOT DEWED)
	CURRENT	0.3A	APPLICABLE CABLE	t=0.20±0.03mm, TIN, TIN-COPPER PLATING

SPECIFICATIONS

ITEM	TEST METHOD	REQUIREMENTS	QT	AT
------	-------------	--------------	----	----

CONSTRUCTION

GENERAL EXAMINATION	VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	X	X
MARKING	CONFIRMED VISUALLY.		X	X

ELECTRIC CHARACTERISTICS

CONTACT RESISTANCE	AC 20mV MAX., 1mA.	100mΩ MAX. INCLUDING FPC BULK RESISTANCE (L=12mm, THICKNESS OF COPPER FOIL: 35μm)	X	X
INSULATION RESISTANCE	100V DC.	50 MΩ MIN.	X	X
VOLTAGE PROOF	90V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	X	X

MECHANICAL CHARACTERISTICS

FPC RETENSION FORCE	MEASURED BY APPLICABLE FPC. (THICKNESS OF FPC SHALL BE t=0.20mm AT INITIAL CONDITION.)	0.15N/PIN MAX. (CONNECTOR, FPC AT INITIAL CONDITION)	X	—
FPC INSERTION FORCE	MEASURED BY APPLICABLE FPC. (THICKNESS OF FPC SHALL BE t=0.20mm AT INITIAL CONDITION.)	0.30N/PIN MIN. (CONNECTOR, FPC AT INITIAL CONDITION)	X	—
MECHANICAL OPERATION	10 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: 100 mΩ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
VIBRATION	FREQUENCY 10 TO 55 Hz, HALF AMPLITUDE 0.75mm, — m/s ² FOR 10 CYCLES IN 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② CONTACT RESISTANCE: 100 mΩ MAX.	X	—
SHOCK	981m/s ² , DURATION OF PULSE 6 ms AT 3 TIMES IN 3 DIRECTIONS.	③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—

ENVIRONMENTAL CHARACTERISTICS

DAMP HEAT (STEADY STATE)	EXPOSED AT 40 °C, RELATIVE HUMIDITY 90 TO 95%, 96h.	① CONTACT RESISTANCE: 100 mΩ MAX. ② INSULATION RESISTANCE: 50 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—
DAMP HEAT, CYCLIC	EXPOSED AT -10 TO +65°C, RELATIVE HUMIDITY 90 TO 96%, 10 CYCLES, TOTAL 240 h.	① CONTACT RESISTANCE: 100 mΩ MAX. ② INSULATION RESISTANCE: 1 MΩ MIN. (AT HIGH HUMIDITY) ③ INSULATION RESISTANCE: 50 MΩ MIN. (AT DRY) ④ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	X	—

REMARKS

REMARKS	DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
Unless otherwise specified, refer to JIS C 5402.	<i>J. Murai</i> 02.04.04	<i>J. Murai</i> 02.04.04	<i>R. Takayanagi</i> 102.04.04	<i>M. Sakurai</i> 02.04.04	

Note QT: Qualification Test AT: Assurance Test X: Applicable Test

HRS HIROSE ELECTRIC CO., LTD.	SPECIFICATION SHEET	PART NO. FH23 - 39S - 0.3SHW
CODE NO. (OLD) CL	DRAWING NO. ELC4 - 153577	CODE NO. CL 586 - 1306 - 3

1/2

SPECIFICATIONS					
ITEM	TEST METHOD		REQUIREMENTS	QT	AT
RAPID CHANGE OF TEMPERATURE	TEMPERATURE -55→+15TO+35→+85→+15TO+35°C TIME 30→ 2~3 → 30→ 2~3 min. UNDER 5 CYCLES.		① CONTACT RESISTANCE: 100 mΩ MAX. ② INSULATION RESISTANCE: 50 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
DRY HEAT	EXPOSED AT 85 °C, 96 h.		① CONTACT RESISTANCE: 100 mΩ MAX.	×	—
COLD	EXPOSED AT -55°C, 96 h.		② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
CORROSION SALT MIST	EXPOSED AT 35°C, 5% SALT WATER SPRAY FOR 96h.		① CONTACT RESISTANCE: 100 mΩ MAX.	×	—
HYDROGEN SULPHIDE [JIS C 0092]	EXPOSED AT 40°C, RELATIVE HUMIDITY 80%, 10 ~ 15 PPM FOR 96h.		② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—
SURPHUR DIOXIDE [JIS C 0090]	EXPOSED AT 40 °C , RELATIVE HUMIDITY 80%, 25 PPM FOR 96 h.		③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR.	×	—
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING : PEAK TMP. 250°C MAX. REFLOW TMP. 230°C MIN FOR 60 sec. 2) SOLDERING IRONS : TMP. 350±5°C FOR 5 sec .		NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	—
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 235°C FOR IMMERSION DURATION, 2 sec.		A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.	×	—

REMARKS

DRAWN

DESIGNED

CHECKED

APPROVED

RELEASED

S. Okamura

02.04.04

J. Murase

02.04.04

R. Takayanagi

02.04.04

M. Ishida

02.04.04



Unless otherwise specified, refer to JIS C 5402.

Note QT:Qualification Test AT:Assurance Test ×:Applicable Test

HRS

HIROSE ELECTRIC CO., LTD.

SPECIFICATION SHEET

PART NO.

FH23 - 39S - 0.3SHW

CODE NO.(OLD)

CL

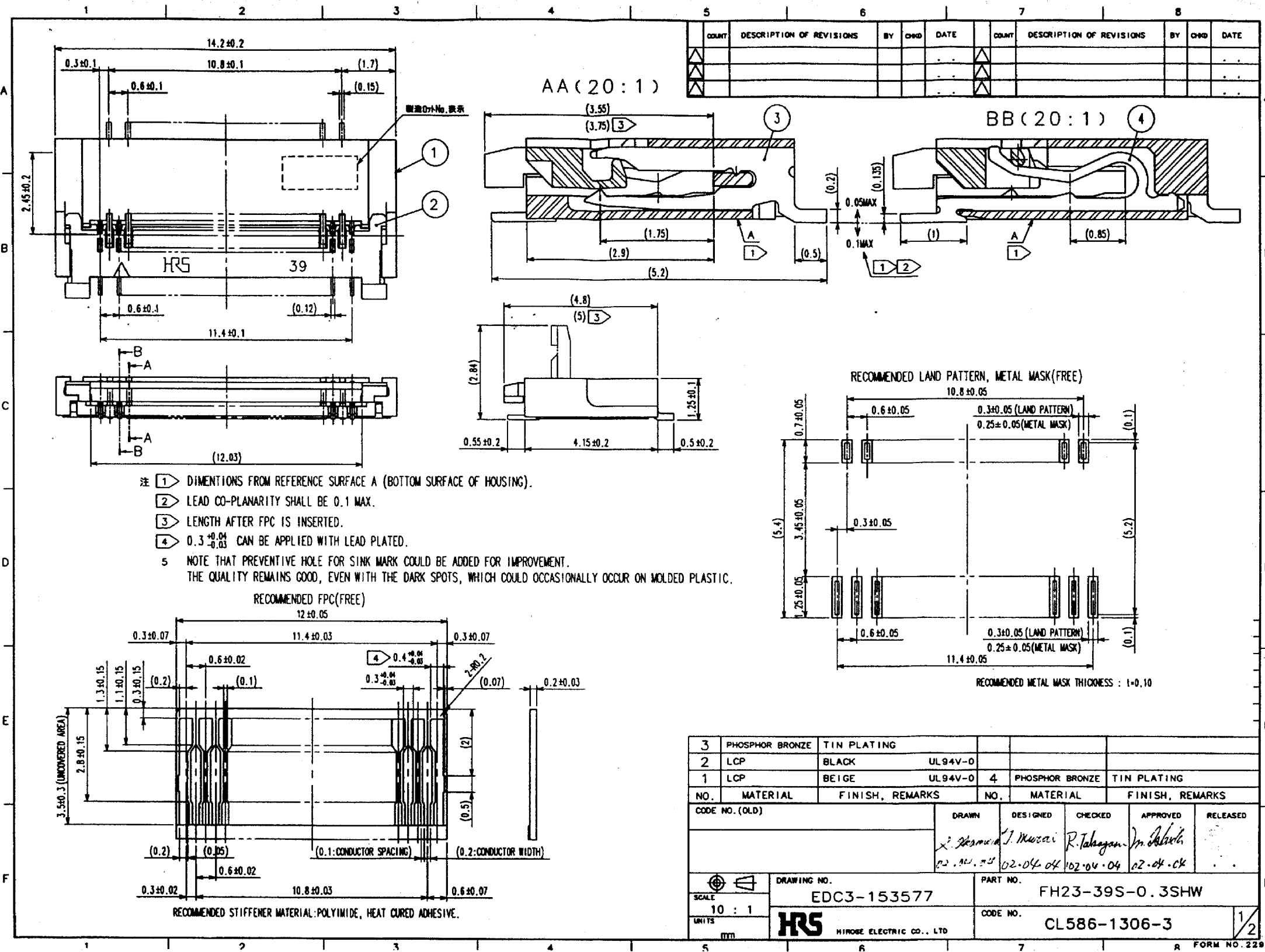
DRAWING NO.

ELC4 - 153577

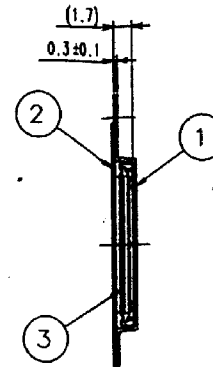
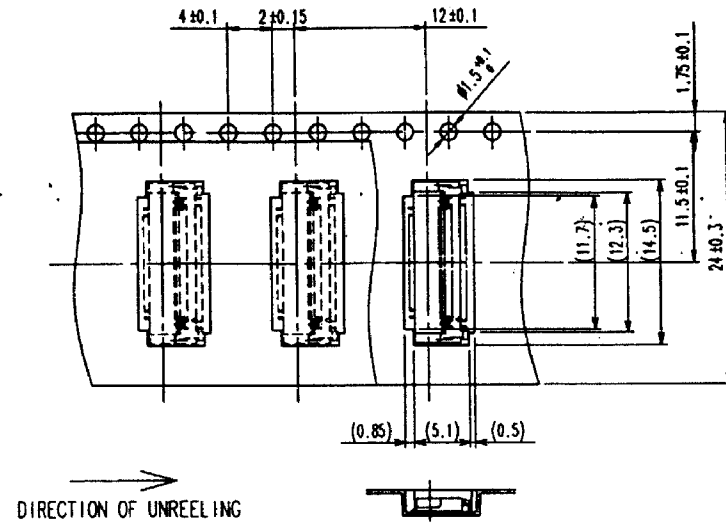
CODE NO.

CL 586 - 1306 - 3

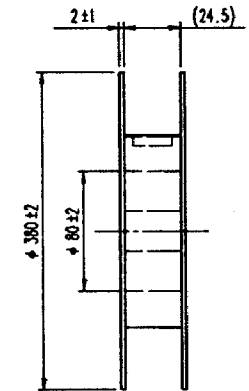
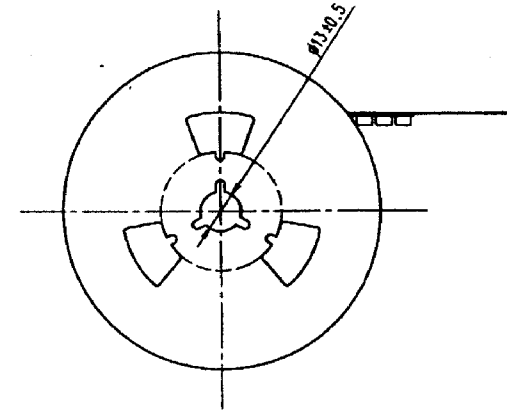
2



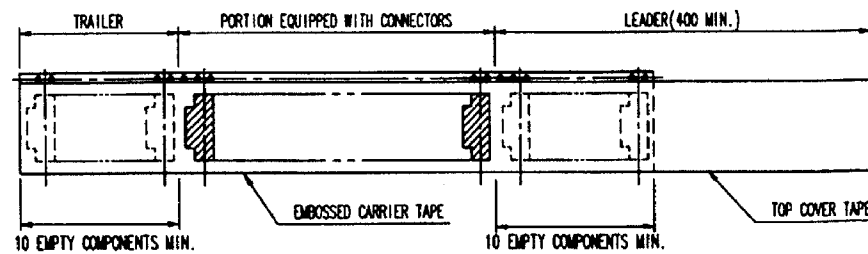
COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
▲					▲				
▲					▲				
▲					▲				



REEL DIMENTION (FREE)



NOTES 1 THE DIMENTIONS IN PARENTHSES ARE FOR REFERENCE.
2 PER REEL : 2500 CONNECTORS.



2	POLYESTER		4		
1	POLYSTYRENE		3	(CONNECTOR)	
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD)			DRAWN DESIGNED CHECKED APPROVED RELEASED		
			A. Okuma 02.04.04 Y. Murai 02.04.04 R. Takayan 02.04.04 M. Takahashi 02.04.04		
DRAWING NO. EDC3-153577			PART NO. FH23-39S-0.3SHW		
SCALE 2 : 1			CODE NO. CL586-1306-3		
UNITS (mm)			HRS HIROSE ELECTRIC CO., LTD.		

材 料 証 明 書
(CERTIFICATE FOR MATERIAL OF PLASTIC PART)

発行日 年 月 日
(DATE)

御 中

(TO:)

品名コード 586
(CODE NO.)

製 品 名 FH23-*S-0.3SHW(05)
(MODEL NO.)

上記の製品には、下記の材料が使用されていることを証明いたします。

(WE HEREBY CERTIFY THAT THE FOLLOWING MATERIAL IS USED FOR THE ABOVE PART.)

この製品への粉砕材(Regrind Material)使用量は、UL746の規定通り、質量比25%以下である。
(Quantity of the use of regrind material to this product is less than 25% of the weight percentage as Regulated in UL746.)

No.	部 品 名 PART NAME	材 料 (MATERIAL)		材料メーカー MANUFACTURER	難燃性/ファイル番号 FLAME CLASS FILE NO.
		材 質 名 GENERIC NAME	型 名 CAT. NO.		
1	絶縁ケース INSERT	L C P 樹脂 LCP	2140GM	上野製薬株式会社 UENO FINE CHEMICALS INDUSTRY LTD	V-0 E122152
2	可動片 LOCK LEVER	L C P 樹脂 LCP	E6008	住友化学工業株式会社 SUMITOMO CHEMICAL CO LTD	V-0 E54705

東北ヒロセ電機株式会社
TOHOKU HIROSE ELECTRIC CO., LTD.

品質管理課 課長 石野 和 明
KAZUAKI ISHINO, MANAGER
QUALITY CONTROL SEC.





QMFZ2 Component - Plastics

Friday, October 24, 2003

E122152

UENO FINE CHEMICALS INDUSTRY LTD

1-127 HIGASHIARIOKA ITAMI-SHI HYOGO-KEN 664-0845 JAPAN

Material Designation: **2140GM(f)(r)**

Product Description: Liquid Crystal Polymer (LCP), furnished as pellets.

Color	Min. Thick. (mm)	Flame Class	HWI	HAI	RTI Elec	RTI Imp	RTI Str	IEC GWIT	IEC GWFI
NC, BK	0.75	V-0	-	-	130	130	130	-	-
NC, BK	1.5	V-0	-	-	130	130	130	-	-
NC, BK	3.0	V-0	-	-	130	130	130	-	-
CTI: -		HVTR: -		D495: -		IEC Ball Pressure (°C): -			
Dielectric Strength (kV/mm): -		Volume Resistivity (10 ^x ohm-cm): -				Dimensional Stability(%): -			
ISO Tensile Strength (MPa): -		ISO Flexural Strength (MPa): -				ISO Heat Deflection (°C): -			
ISO Tensile Impact (kJ/m ²): -		ISO Izod Impact (kJ/m ²): -				ISO Charpy Impact (kJ/m ²): -			

(f) May be suffixed by one, two, or three letters except F

(r) Virgin and regrind material up to 50% by weight has the same V-0 rating. No other properties for regrind between 25% - 50% have been evaluated.

Report Date: 11/6/1998

Underwriters Laboratories Inc®

UL94 small-scale test data does not pertain to building materials, furnishings and related contents. UL 94 small-scale test data is intended solely for determining the flammability of plastic materials used in components and parts of end-product devices and appliances, where the acceptability of the combination is determined by ULI.



QMFZ2 Component - Plastics

Friday, October 24, 2003

E54705

SUMITOMO CHEMICAL CO LTD

5-33 KITAHAWA 4-CHOME CHUO-KU OSAKA 541-8550 JAPAN

Material Designation: **E6008**

Product Description: Liquid Crystal Polymer (LCP), designated "SUMIKASUPER" furnished as pellets.

Color	Min. Thick. (mm)	Flame Class	HWI	HAI	RTI Elec	RTI Imp	RTI Str	IEC GWIT	IEC GWFI
ALL	0.54	V-0	-	-	130	130	130	-	-
	0.75	V-0	-	-	220	180	220	-	-
	1.5	V-0	2	4	220	200	240	-	-
	3.0	V-0	1	4	220	200	240	-	-

CTI: 3**HVTR: 0****D495: 5****IEC Ball Pressure (°C): -****Dielectric Strength (kV/mm): -****Volume Resistivity (10⁹ohm-cm): -****Dimensional Stability(%): -****ISO Tensile Strength (MPa): -****ISO Flexural Strength (MPa): -****ISO Heat Deflection (°C): -****ISO Tensile Impact (kJ/m²): -****ISO Izod Impact (kJ/m²): -****ISO Charpy Impact (kJ/m²): -**

Report Date: 10/31/1990

Underwriters Laboratories Inc®

UL94 small-scale test data does not pertain to building materials, furnishings and related contents. UL 94 small-scale test data is intended solely for determining the flammability of plastic materials used in components and parts of end-product devices and appliances, where the acceptability of the combination is determined by ULI.



Test Report

HIROSE ELECTRIC CO., LTD.

5-23, OSAKI 5-CHOME, SHINAGAWA-KU, TOKYO 141-
8587, JAPAN

Report No. : CE/2006/51366

Date : 2006/05/11

Page : 1 of 5

The following merchandise was (were) submitted and identified by the client as :

Type of Product : CONNECTOR
Style/Item No : FH23-*S-0.3SH(A)W(05)
Sample Received : 2006/05/04
Testing Date : 2006/05/04 TO 2006/05/11

=====

Test Result : - Please see the next page -


Daniel Yeh, M.R., Operation Manager
Signed for and on behalf of
SGS TAIWAN LTD.

Any unauthorized alteration, forgery or falsification of the content or appearance of this report is unlawful and offenders may be prosecuted to the fullest extent of the law. 對本報告內容或外觀之任何未經授權之變更、偽造、竄改皆屬非法，違犯者將會被依法追訴。

The content of this PDF file is in accordance with the original issued reports for reference only. This Test Report cannot be reproduced, except in full, without prior written permission of the Company



Test Report

HIROSE ELECTRIC CO., LTD.
5-23, OSAKI 5-CHOME, SHINAGAWA-KU, TOKYO 141-
8587, JAPAN

Report No. : CE/2006/51366

Date : 2006/05/11

Page : 2 of 5

Test Result

PART NAME NO.1 : BEIGE PLASTIC
PART NAME NO.2 : BALCK PLASTIC
PART NAME NO.3 : GOLDEN COLORED METAL TERMINAL

Test Item (s):	Unit	Method	MDL	Result		
				No.1	No.2	No.3
Monobromobiphenyl	%	With reference to USEPA3540C or USEPA3550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005	N.D.	N.D.	---
Dibromobiphenyl	%		0.0005	N.D.	N.D.	---
Tribromobiphenyl	%		0.0005	N.D.	N.D.	---
Tetrabromobiphenyl	%		0.0005	N.D.	N.D.	---
Pentabromobiphenyl	%		0.0005	N.D.	N.D.	---
Hexabromobiphenyl	%		0.0005	N.D.	N.D.	---
Heptabromobiphenyl	%		0.0005	N.D.	N.D.	---
Octabromobiphenyl	%		0.0005	N.D.	N.D.	---
Nonabromobiphenyl	%		0.0005	N.D.	N.D.	---
Decabromobiphenyl	%		0.0005	N.D.	N.D.	---
Total PBBs (Polybrominated biphenyls)/Sum of above	%		-	N.D.	N.D.	---
Monobromobiphenyl ether	%	With reference to USEPA3540C or USEPA3550C. Analysis was performed by HPLC/DAD, LC/MS or GC/MS. (prohibited by 2002/95/EC (RoHS), 83/264/EEC, and 76/769/EEC)	0.0005	N.D.	N.D.	---
Dibromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Tribromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Tetrabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Pentabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Hexabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Heptabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Octabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Nonabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Decabromobiphenyl ether	%		0.0005	N.D.	N.D.	---
Total PBBEs(PBDEs) (Polybrominated biphenyl ethers)/Sum of above	%		-	N.D.	N.D.	---
Total of Mono to Nona-brominated biphenyl ether. (Note 4)	%		-	N.D.	N.D.	---

Any unauthorized alteration, forgery or falsification of the content or appearance of this report is unlawful and offenders may be prosecuted to the fullest extent of the law. 對本報告內容或外觀之任何未經授權之變更、偽造、篡改皆屬非法，違犯者將會被依法追訴。

The content of this PDF file is in accordance with the original issued reports for reference only. This Test Report cannot be reproduced, except in full, without prior written permission of the Company



Test Report

HIROSE ELECTRIC CO., LTD.

5-23, OSAKI 5-CHOME, SHINAGAWA-KU, TOKYO 141-8587, JAPAN

Report No. : CE/2006/51366

Date : 2006/05/11

Page : 3 of 5

Test Item (s):	Unit	Method	MDL	Result		
				No.1	No.2	No.3
Chromium VI (Cr+6)	ppm	UV-VIS(US EPA 7196A) after reference to US EPA 3060A.	2	N.D.	N.D.	N.D.
Cadmium (Cd)	ppm	ICP-AES after reference to EN 1122, method B:2001 or other acid digestion.	2	N.D.	N.D.	N.D.
Mercury (Hg)	ppm	ICP-AES after reference to US EPA 3052 or other acid digestion.	2	N.D.	N.D.	N.D.
Lead (Pb)	ppm	ICP-AES after reference to US EPA 3050B or other acid digestion.	2	N.D.	N.D.	11.2

NOTE: (1) N.D. = Not detected (<MDL)

(2) ppm = mg/kg

(3) MDL = Method Detection Limit

(4) Decabromodiphenyl ether (DecaBDE) in polymeric applications is exempted by Commission Decision of 13 Oct 2005 amending Directive 2002/95/EC notified under document 2005/717/EC.

(5) PBBEs=PBDEs=Polybrominated Diphenyl Ethers=PBDOs=PBBOs.

(6) " - " = Not Regulation

(7) " --- " = Not Applicable

Any unauthorized alteration, forgery or falsification of the content or appearance of this report is unlawful and offenders may be prosecuted to the fullest extent of the law. 對本報告內容或外觀之任何未經授權之變更、偽造、竄改皆屬非法，違犯者將會被依法追訴。

The content of this PDF file is in accordance with the original issued reports for reference only. This Test Report cannot be reproduced, except in full, without prior written permission of the Company

Test Report

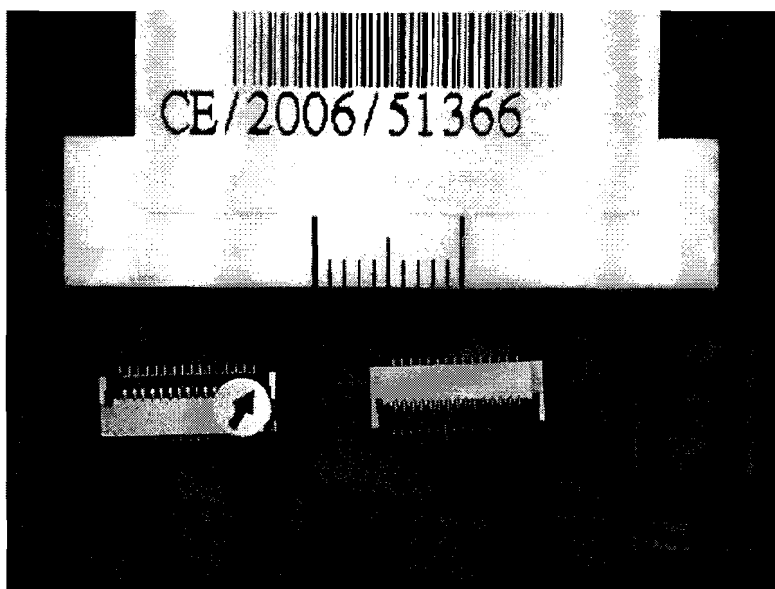
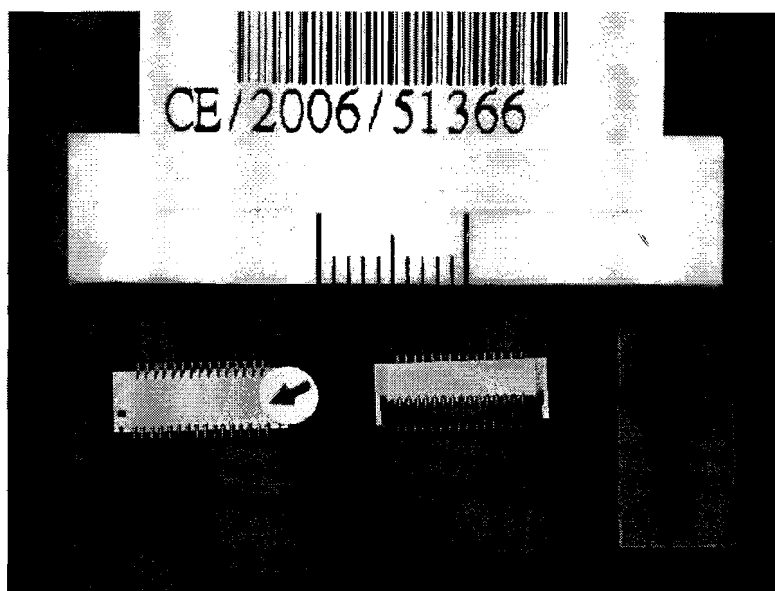
HIROSE ELECTRIC CO., LTD.

5-23, OSAKI 5-CHOME, SHINAGAWA-KU, TOKYO 141-
8587, JAPAN

Report No. : CE/2006/51366

Date : 2006/05/11

Page : 4 of 5



Any unauthorized alteration, forgery or falsification of the content or appearance of this report is unlawful and offenders may be prosecuted to the fullest extent of the law. 對本報告內容或外觀之任何未經授權之變更、偽造、竄改皆屬非法，違犯者將會被依法起訴。

The content of this PDF file is in accordance with the original issued reports for reference only. This Test Report cannot be reproduced, except in full, without prior written permission of the Company.

Test Report

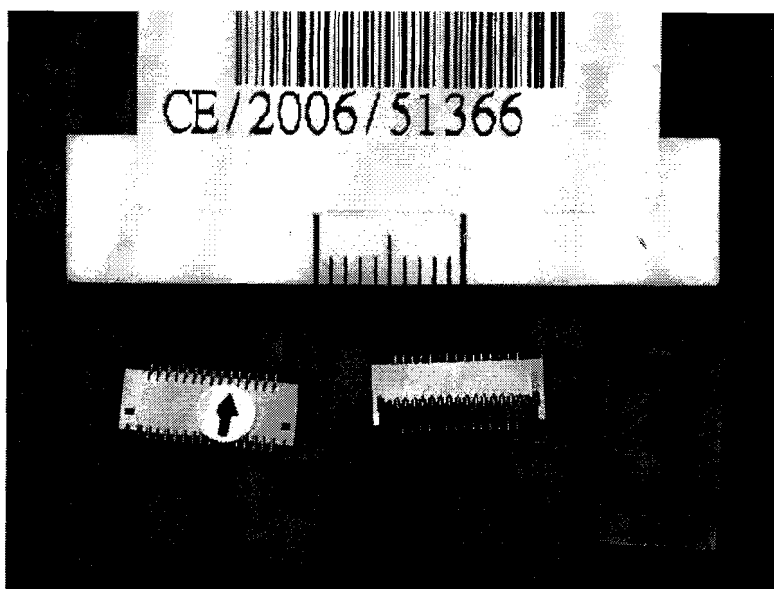
HIROSE ELECTRIC CO., LTD.

5-23, OSAKI 5-CHOME, SHINAGAWA-KU, TOKYO 141-
8587, JAPAN

Report No. : CE/2006/51366

Date : 2006/05/11

Page : 5 of 5



Any unauthorized alteration, forgery or falsification of the content or appearance of this report is unlawful and offenders may be prosecuted to the fullest extent of the law. 對本報告內容或外觀之任何未經授權之變更、偽造、竄改皆屬非法，違犯者將會被依法追訴。

The content of this PDF file is in accordance with the original issued reports for reference only. This Test Report cannot be reproduced, except in full, without prior written permission of the Company

